COMPACT, SCALABLE, HIGH-RESOLUTION, MEMS-ENABLED TACTILE DISPLAYS

X. Xie¹, Y. Zaitsu√, L.F. Velásquez-García², S. Teller³, and C. Livermore¹
¹Northeastern University, Boston, Massachusetts, USA
²Massachusetts Institute of Technology, Cambridge, Massachusetts, USA

ABSTRACT

The design, fabrication, and test of a new type of tactile display for the blind is reported. An array of piezoelectric extensional actuators vibrates in plane, and microfabricated scissor mechanisms convert the in-plane actuations into robust, higher-amplitude, out-of-plane vibrations. Information can be conveyed by varying the vibration patterns in space and time. Analytical and FEM models were used to design individual tactile elements, which were implemented with PZT actuators and both SU-8 and 3D-printed scissor amplifiers. The measured displacements of 3 mm x 10 mm tactile elements exceed 10 μm, in agreement with models, with measured forces exceeding 45 mN. The creation of a 28-element prototype is also reported.

INTRODUCTION

Providing information to those who are blind or have low vision is critical for enhancing mobility, situational awareness, education, and more. Tactile information delivery can be effective, rapid, and private. Examples include Braille [1,2] and the Optacon [3], both of which convey text to the user through the motion of several-centimeter-long piezoelectric bending beam actuators. Graphical information that cannot be expressed as text is most commonly embossed on paper. Although refreshable 2D graphical interfaces are preferred, it is challenging to create actuators that are compact enough to be arrayed into an unlimited number of rows and columns while still being robust, easy to sense, and rapidly switchable. Electroactive polymer actuators are small enough to be arrayed with a few millimeter pitch and provide quasi-static millimeter-scale actuations, but they typically have actuation times on the order of seconds (see [4] and references therein). An alternative integrates piezoelectric bending beam actuators perpendicular to the tactile sensing plane, enabling large bending beam actuators to be tightly packed for fully 2D displays [5,6]. MEMS technology is also increasingly being leveraged to create tactile displays, as in [7-9]. Important challenges nonetheless remain, including spatial resolution, refresh rate, and cost.

Ideally, the display’s resolution should leverage the approximately one receptor per mm² spacing of mechanoreceptors in human finger pads and be extendable to full 2D. It should be refreshable in real time, allowing the contents of the display to keep up with rapidly changing inputs. The display should also code information in a way that is easily detected and interpreted. Since humans are much more sensitive to motions and changing stimuli than they are to static patterns [10], the display should code information not only as static patterns, but also as simulated motion against the user’s finger pads. Finally, its power consumption should be compatible with portable use, and it should be manufacturable by efficiently scalable means to ensure that its cost is compatible with the resources of its target user base. Although existing displays have met various subsets of these requirements, no existing display has been able to meet all of these requirements simultaneously.

This paper presents the concept, design and modeling, fabrication, and characterization of a new type of tactile actuator created to target these requirements. This new actuator concept comprises a single-layer, 2D array of in-plane, extensional piezoelectric actuators, each of which is capped with a scissor amplifier and blunt “pin” that the user feels with his or her fingers (Figure 1). When the extensional actuators expand and contract, the tops of the scissors fall and rise. The ratio of scissor amplitude to actuator amplitude depends on the scissor angle. In the final display, each actuator is driven with an oscillating voltage to create patterns of vibration on the display surface.

This display concept is dictated by the requirements above. To minimize cost, the design avoids the large, multi-layer actuators of refreshable Braille. The tactile elements (tactels) comprise a single layer of actuators to enable scalable integration to 2D. The technology is compatible with down-scaling tactels to the 1-2 mm² scale, but actuators with such a small footprint can be expected to create smaller vibrations than larger actuators can. The actuators are therefore designed to operate between tens and hundreds of Hz, where humans sense small actuations most readily [11]. This high frequency design is also consistent with rapid refreshability and the creation of moving patterns. The use of high frequency actuations eliminates polymer actuators and supports the use of piezoelectric, magnetic, or shape memory alloy actuators. Among these, the need to minimize power favors piezoelectrics. Finally, the actuator plus scissor amplifier architecture maximizes the vibrational amplitudes that the system can create from a small extensional actuator.

![Schematic diagram of piezoelectric extensional actuators (red) topped by scissor amplifiers (light blue) and cap plate.](image)

**Figure 1:** Schematic diagram of piezoelectric extensional actuators (red) topped by scissor amplifiers (light blue) and cap plate.

**DESIGN**

**Device Specifications**

The initial specification for vibrational amplitude was set to >10 μm to accommodate the wide range of human finger sensitivities at tens to hundreds of Hz. This threshold has been validated through laboratory testing of the devices presented below. Although many individuals can detect vibrations at or below the few micron scale, the ability to use amplitudes of >10 μm remains useful. In practice, the frequency can be varied between 10 Hz and 400 Hz to create different user experiences.

Actuator force can also matter for sensing; if the tactile element has insufficient stiffness, the force that it applies to the user’s fingers may be too small for robust detection. A design specification of > 10 mN of oscillatory force for most users is chosen by correlating measured forces with the user experience.

**Ideal Tactel Performance**

The piezoelectric extensional actuators comprise γ-poled lead zirconate titanate (PZT) bilayer beams that are actuated by
applying a voltage between electrodes on their top and bottom surfaces. The scissor converts the resulting lengthwise extension or contraction into vertical displacement. For a scissor with ideal pinned hinges, the scissor’s vertical displacement $\Delta y$ is related to the PZT’s lengthwise extension $\Delta x$ by $\Delta y = \Delta x \cot(\theta)$, where $\theta$ is the angle between scissor and actuator (Figure 2). The ratio of vertical displacement to horizontal displacement (the amplification factor) can be large when the scissor angle $\theta$ is small. For example, an angle of $1.25^\circ$ corresponds to an amplification factor of $>45$.

**Figure 2: Geometrical parameters for tactel with ideal scissor.**

User-applied loads during sensing can impart forces to the PZT beams and scissor amplifiers, affecting the system’s performance. For an ideal scissor with rigid arms and pinned hinges, the vertical force $F$ applied at the scissor’s peak produces larger axial forces of $F/(2\sin(\theta))$ in the scissor arms. The axial forces in turn apply vertical forces of $F\cot(\theta)/2$ at the ends of the PZT beam. The vertical forces tend to bend the PZT and must be limited to prevent breakage. The horizontal forces tend to stretch the PZT and will oppose its contraction. The relationship among the horizontal force from the user, the blocking force, and the target displacement drive the design. A smaller scissor angle offers larger amplification, but a larger scissor angle reduces deflection limits due to the blocking force. Figure 3 illustrates the amplification/blocking force tradeoff by plotting predicted vibrational amplitude vs. scissor angle for tactels using both a MEMS scale actuator (2500 $\mu$m x 400 $\mu$m x 250 $\mu$m) with an applied voltage of 150 V and a milliscale actuator (10 mm x 3 mm x 0.38 mm) with an applied voltage of 100 V. The user-applied force per tactel is taken to be 0.1 N. The maximum deflections are calculated as 15.5 $\mu$m at an angle of $1.1^\circ$ and 55.1 $\mu$m at 0.25$^\circ$ for MEMS and milliscale tactels, respectively. The optimal scissor angle for this applied force is therefore in the range of about $1^\circ$ or less, depending on the size scale.

Supporting the actuator at the center frees its ends to move in extension and contraction, but the suspended ends can bend or break under applied loads. The maximum stress in the PZT under an applied load of 0.1 N was calculated at 40 MPa and 26 MPa for the MEMS-scale and milliscale devices, respectively, less than the predicted failure stress of 90 MPa. Deflection-limiters are included for additional safety. First, the ends of the actuator beams rest on underlying support surfaces. Second, the tactile display is capped by a perforated plate. The user can sense the pins’ vibration where they protrude through the holes, but the cap prevents overdeflection of the tactile elements under load. The cap also provides electrical isolation and prevents tactile distraction.

The key advantage of this architecture as compared with the bending beam actuators of refreshable Braille is that it enables both robustness and large amplitude actuations. The thick, short extensional actuator creates large actuation forces while providing excellent robustness against bending under user-applied load, and the scissor amplifier converts the resulting small, in-plane deflections into large vibrations. In contrast, a piezoelectric bending beam of comparable length would have to be thinner than the actuators used here to achieve sufficient vibrational amplitude, and its thinness would sacrifice robustness against applied forces.

**Figure 3: Plot of predicted deflection amplitude as a function of scissor angle for actuators at the MEMS and milli scales.**

**Scissor Design**

For ease of fabrication, the present scissors use bending flexures in place of pinned hinges. Figure 4a shows a diagram of the flexural scissor along with its integrated sensing pin. The dimensions of the nominally rigid elements and the flexural hinges are chosen to ensure that the actuator force is sufficient to make the peak of the scissor vibrate and that the scissor does not deform excessively or experience excessive stress under applied loads. Finite element analysis (FEA) was used to predict the performance of the scissors under actuation and user-applied loads. To avoid fatigue, the maximum acceptable stress was set to 100 MPa, about 20 times less than the failure stress of SU-8 and the 3D printed material. Based on these results, the hinges are designed with thickness $t_h$ of 300 $\mu$m for the SU-8 hinges and 400 $\mu$m for the 3D printed hinges; the hinge widths $w_h$ are designed as 1.5 mm and 2.8 mm for the SU-8 and 3D-printed scissors, respectively. The hinge length $l_h$ for both scissor types is 800$\mu$m out of a total 9.6 mm length. Each scissor includes a 6 mm tall sensing pin. The FEA results of Figure 4b show that the predicted peak displacement of an SU-8 scissor with the final, as-fabricated dimensions under an anchor displacement corresponding to an applied voltage of 95 V is 2 $\mu$m (corresponding to a peak-to-peak amplitude of 4 $\mu$m). The maximum stress in this case is 34 MPa.

**Figure 4: (a) Diagram of scissor with flexural hinges and (b) deformation ($\mu$m) of SU-8 scissor under 95 V predicted using FEA.**

**FABRICATION**

The individual tactels include a combination of micro and milliscale features. Custom y-poled PZT actuators (Piezo Systems, Inc.), laser cut to 10 mm x 3 mm x 380 $\mu$m, comprise the in-plane actuators. The scissor actuators were manufactured by two
methods, photolithographic definition in 1.5 mm thick SU-8 and 3D printing. To pattern the SU-8 scissors, 40 nm of OmniCoat (MicroChem) was spun onto a silicon substrate in three layers. A 1.5 mm thick double layer of SU-8 2150 (MicroChem) was spun over the OmniCoat and patterned photolithographically. The OmniCoat was dissolved to lift the SU-8 scissors off the substrate. The 3D-printed scissors were defined from VeroBlack Fullcure 870 UV-curable resin in an Objet Eden 333 3D printer. The as-fabricated hinge dimensions are 800 µm long x 1470 µm wide x 270 µm thick and 800 µm long x 2900 µm wide x 390 µm thick for the SU-8 and 3D-printed scissors, respectively. The difference in hinge thickness primarily reflects the use of two different designs. The difference in scissors width reflects SU-8 thickness.

Although larger arrays of tactels would ultimately be soldered to a base plate (e.g. a printed circuit board), the devices for single tactel testing and small array tests were connected by soldering wires to nickel electrodes on the upper and lower actuator surfaces. The scissors were adhered to the actuators with a cyanoacrylate adhesive. For single tactel testing, the alignment of the scissors to the actuator did not affect performance, and no provisions were made for alignment. The final tactels are shown in Figure 5.

Figure 5: Photographs of fabricated tactels with (a) SU-8 and (b) 3D printed scissors.

For array fabrication, alignment is critical because the sensing pins must align with the holes in the cap plate. The scissors were mechanically aligned to the actuators using a reference surface. Twenty-eight actuators and scissors were then aligned by electrically insulating mechanical stops in a passive alignment plate. The tactels form an offset array to minimize pitch. A thin foam interlayer placed between the actuators and the alignment plate prevents parasitic vibrations on neighboring pins but also somewhat reduces the vibrational signal at the pin. The electrical wires pass through vias in the alignment plate and are soldered to an underlying printed circuit board. The alignment plate provides mechanical support to prevent deflection of the actuator under load. A mechanical spacer controls the height of the cap plate to ensure that the pins protrude by approximately 300 µm, and all plates are aligned relative to each other by a set of alignment pins. The package and its alignment features are shown in Figure 6.

Figure 6: Photograph of 28-element tactile array during assembly.

EXPERIMENT

The individual tactels were mounted on a testing stage under an optical stereomicroscope so that deformations of the scissor were visible in the microscope’s viewing plane, and displacement was measured under actuation. Square wave voltages with a frequency of 0.5 Hz were output by a function generator and amplified to achieve peak voltage amplitudes of up to 170 V. The voltage was increased in 10 V steps from a starting value of 40 V to the maximum value of 170 V. Two or three images of the tactel in each of its maximum and minimum positions for each voltage were captured using a microscope camera. The scissors were placed to measured force by counting pixels; the 1.16 µm pixelization dominates the measurement error.

The measured peak-to-peak displacement is plotted in Figure 7. The markers represent data points, and the error bars reflect a +/- one pixel measurement error. The solid lines are the displacement predicted analytically for a tactel with an ideal, pinned-hinge scissor. For the purposes of this calculation, the flexural hinges are approximated as pinned hinges located on the neutral plane of the flexural hinge directly adjacent to the anchor support and the central pin. For the device with an SU-8 scissor, the displacement ranges from a minimum of 3.8 µm measured at 40 V to a maximum of 10.7 µm measured at 170 V. For the device with a 3D printed scissor, the displacement ranges from 2.7 µm to 8.9 µm over that voltage range. In all cases, the increase in displacement with applied voltage is similar to the linear trend that is predicted using the ideal pinned hinge model. The FEA model slightly under-predicts the measured displacement at 95 V (2 µm peak predicted as compared with ~3 µm peak determined from the measured ~6 µm peak-to-peak displacement). The larger displacement of the SU-8 scissors for the same voltage reflects the SU-8 scissors’ thinner hinge and narrower width, both of which reduce its mechanical stiffness under horizontal actuation.

To measure the amplitude of the force that the tactels apply when they vibrate in contact with a rigid surface, the individual tactels were mounted on a second testing stage that is mounted to the grips of a mechanical tester (Instron 5943). The tensile tester was preloaded to apply a force of 40 mN to the sensing pin when zero voltage was applied. A square wave voltage with a frequency of 10 Hz was applied to the tactel, and its peak amplitude was increased from 40 V to 170 V in increments of 10 V. The resulting forces were measured by the mechanical tester’s load cell. The raw data were post-processed in MATLAB to eliminate signals at frequencies other than 10 Hz (noise and drift).

Figure 7: Plot of tactel displacement vs. applied voltage measured with SU-8 and 3D-printed scissors and predicted for ideal scissors.
Figure 8 plots the measured peak-to-peak amplitude of the tactel’s oscillating force. The markers represent the measured forces, and the connecting lines are included as guides to the eye. Each force measurement is repeated over 15 to 20 voltage cycles, resulting in 15 to 20 nominally identical force measurements. The error bars represent the maximum variation that was observed between nominally identical repeated measurements. Whereas the measured displacements were similar for the SU-8 and 3-D printed devices and matched the models well in all cases, the measured forces differ widely between the designs. The forces from the tactel with the 3D printed scissor have larger values, increasing from 6.9 mN at 40 V to 48.7 mN at 170 V. The forces from the tactel with the SU-8 scissor are smaller, ranging from 2.3 mN to 14.7 mN. The lower forces from the tactel with the SU-8 scissor primarily reflect the SU-8 scissor’s lower stiffness due to differences in geometry (hinge thickness and width); their Young’s modulus values are similar.

**CONCLUSION**

Tactile elements based on the actuator plus amplifier design are shown to be effective at the milliscale. Their measured performance agrees with the models, with maximum deflections of greater than 10 \( \mu \text{m} \) and maximum forces above 45 mN that place the devices well above the sensing threshold. An analytical model based on ideal pinned hinges is shown to be useful for predicting the behavior of tactels with flexural hinges, especially when coupled with FEA to predict hinge failure. The analytical model validation provides support for further downscaling of the tactile elements to the 1-2 mm\(^2\) scale, since the models also predict successful functioning at this scale. At the MEMS scale, the display’s resolution would correspond to up to 100 tactels/cm\(^2\).

The measured performance confirms sensing thresholds of less than 4 \( \mu \text{m} \) and 2 mN for the most effective tactile devices.

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**CONTACT**

*X.Xie, tel: +1-617-373-2048; x.xie@neu.edu*